Segmented Photodiodes (SPOT Series)

Position Sensing Detector (PSD)

The SPOT Series are common substrate photodetectors segmented into either two (2) or four (4) separate active areas. They are available with either a 0.005" or 0.0004" well defined gap between the adjacent elements resulting in high response uniformity between the elements. The SPOT series are ideal for very accurate nulling or centering applications. Position information can be obtained when the light spot diameter is larger than the spacing between the cells.

Spectral response range is from 350-1100nm. Notch or bandpass filters can be added to achieve specific spectral responses.

These detectors exhibit excellent stability over time and temperature, fast response times necessary for high speed or pulse operation, and position resolutions of better than 0.1 μ m.

Maximum recommended power density is 10 mW / cm2 and typical uniformity of response for a 1 mm diameter spot is $\pm 2\%$.

The circuit on the opposite page represents a typical biasing and detection circuit set up for both bi-cells and quad-cells. For position calculations and further details, refer to "Photodiode Characteristics" section of the catalog.

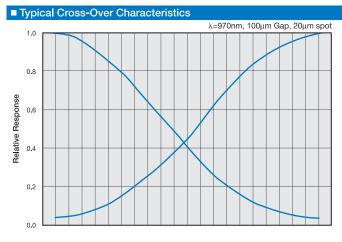


APPLICATIONS

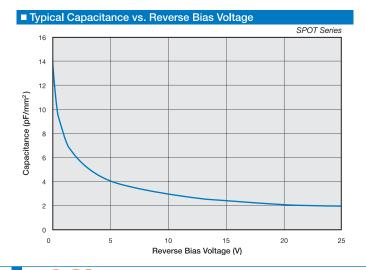
- Machine Tool Alignment
- Position Measuring
- Beam Centering
- Surface Profiling
- Targeting
- Guidance Systems

FEATURES

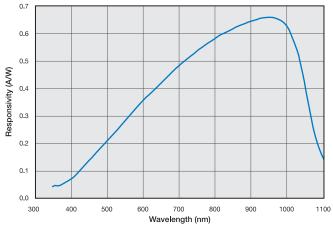
- High Accuracy
- Excellent Resolution
- High-Speed Response
- Ultra Low Dark Current
- Excellent Response Match
- High Stability over Time and Temperature



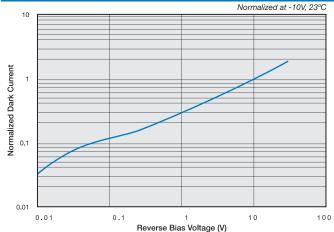
1 division = $10 \mu m$



Typical Spectral Response





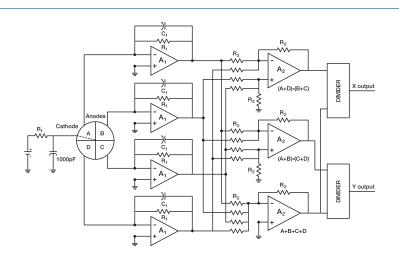


Typical Electro-Optical Specifications at T_A=23°C

Model Number	Active Area Per Element		Gap (mm)	Responsivity (A/W)		Capacitance (pF)	Dark Current (nA)		NEP (W/√Hz)	Reverse Voltage	Rise Time (ns)	Temp Range (°C)		
	Area (mm²) Dimensions	nsions m)	Element Gap	970 nm		-10 V	-10 V		-10 V 970 nm	(V)	-10 V 780 nm 50 Ω	Operating	Storage	Package Style ¶
		Dime (m		min.	typ.	typ.	typ.	max.	typ.	max.	typ.	Opei	Sto	
Two-Element Series, Metal Package														
CD-25T	2.3	4.6 x 0.5	0.2	0.60	0.65	50@ -15V	20@ -:	15V	1.1 e-14	30	300@ -15V	-40 ~ +100	-55 ~ +125	2 / TO-5
SPOT-2D	3.3	1.3 x 2.5	0.127			11	0.15	2.0	1.1 e-14		5			41 / TO-5
SPOT-2DMI	0.7	0.6 x 1.2	0.013			3	0.05	1.0	6.2 e-15		7			40 / TO-18
SPOT-3D	2.8	0.6 x 4.6	0.025			7	0.13	2.0	9.9 e-15		4			41 / TO-5
Four Element Series, Metal Package														
SPOT-4D	1.61	1.3 sq	0.127	0.60	0.65	5	0.10	1.0	8.7 e-15	30		+100	+125	41 / TO-5
SPOT-4DMI	0.25	0.5 sq	0.013			1	0.01	0.5	2.8 e-15		3			41/10-5
SPOT-9D	19.6	10 o ‡	0.102			60	0.50	10.0	1.9 e-14		5	40 ∼	55 ~	43 / LoProf
SPOT-9DMI	19.6	τυψ+	0.010									4	Ϋ́	

Model Number	Active Area Per Element		(mm)	Responsivity 257 nm		Capacitance 0 V	Shunt Resistance (MΩ)		NEP Reverse Voltage	Rise Time 0 V, 257 nm				
	Area (mm²)	ş	Element Gap	A/W		pF	(1132)		(W/\/Hz)		μs	Package		
		Dimensio (mm)		min.	typ.	typ.	min.	min. max.		max.	typ.	Style ¶		
UV-Enhanced Four Elements, Metal Package §														
SPOT-4DUV	1.61	1.3 sq	0.127	0.08	0.10	40	100	500	1.3 e-13	5	10	-10 ~ +60	-20 ~ +70	41 / TO-5

 \ddagger Overall Diameter (All four Quads) \P For mechanical drawings please refer to pages 58 thru 69. Chip centering within $\pm 0.010".$



1. Parameter Definitions:

- A = Distance from top of chip to top of glass.
- a = Photodiode Anode.
- B = Distance from top of glass to bottom of case.
- c = Photodiode Cathode
- (Note: cathode is common to case in metal package products unless otherwise noted).
- W = Window Diameter.
- F.O.V. = Filed of View (see definition below).

2. Dimensions are in inches (1 inch = 25.4 mm).

3. Pin diameters are 0.018 ± 0.002" unless otherwise specified.

4. Tolerances (unless otherwise noted) General: 0.XX ±0.01" 0.XXX ±0.005" Chip Centering: ±0.010"

Dimension 'A': ±0.015"

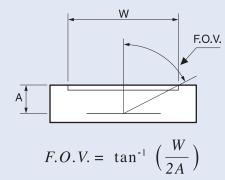
5. Windows

All '**UV**' Enhanced products are provided with QUARTZ glass windows, 0.027 \pm 0.002" thick.

All 'XUV' products are provided with removable windows.

All '**DLS**' PSD products are provided with A/R coated glass windows.

All 'FIL' photoconductive and photovoltaic products are epoxy filled instead of glass windows.





Mechanical Specifications and Die Topography

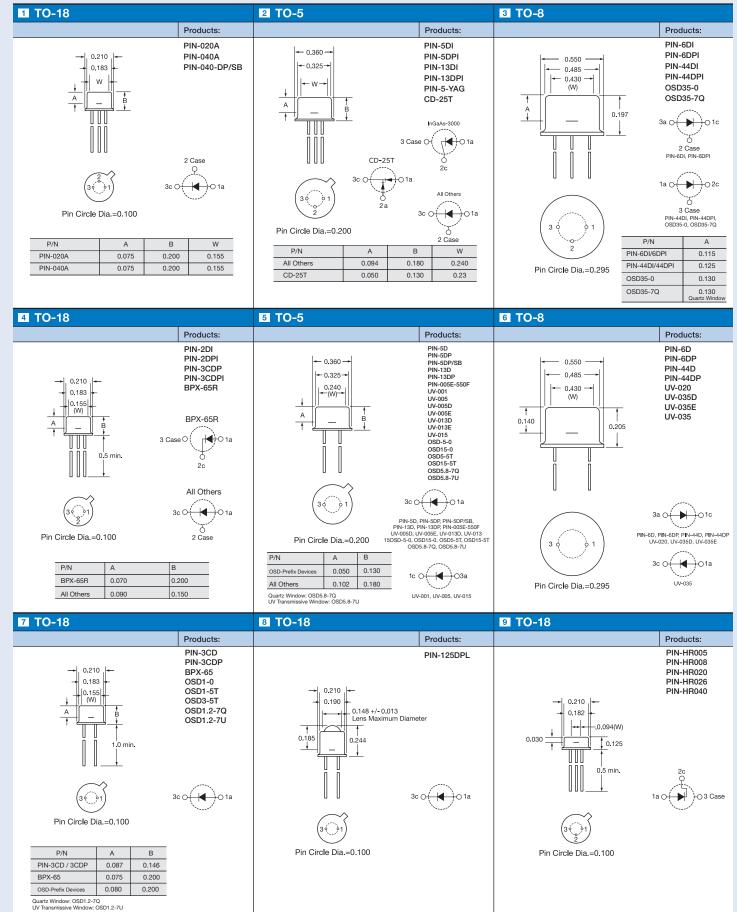
For Further Assistance Please Call One of Our Experienced Sales and Applications Engineers

310-978-0516

- Or -On the Internet at WWW.OSioptoelectronics.com

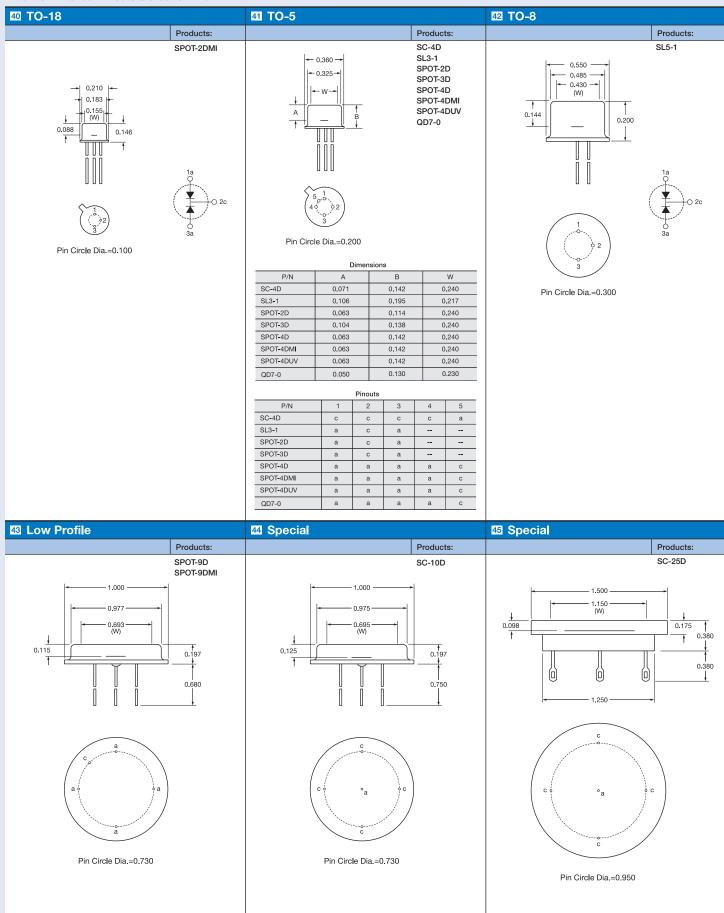
Mechanical Specifications

All units in inches. Pinouts are bottom view.



Mechanical Specifications

All units in inches. Pinouts are bottom view.



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